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Product Change Notification - JAON-13MHBC653 (Printer Friendly)

Date:

01 May 2017

Product Category:

Capacitive Touch Sensors

Notification subject:

CCB 2662 and 2662.001 Final Notice: Qualification of ANAP assembly site for selected products of the 0.18 um Global Foundries wafer technology available in 8L and 14L SOIC package.

Notification text:

PCN Status:

Final notification

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of ANAP assembly site for selected products of the 0.18 um Global Foundries wafer technology available in 8L and 14L SOIC package.

Pre Change:

Assembled at MTAI assembly site

Post Change:

Assembled at MTAI or ANAP assembly site

Pre and Post Change Summary:

	Pre Change	Post (ost Change				
Assembly Site	MTAI assembly site	MTAI assembly site	ANAP Assembly Site				
Wire material	Au wire	Au wire	Au wire				
Die attach material	8390A	8390A	8290				
Molding compound material	G600	G600	G600				
Lead frame material	C194	C194	C194				

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve manufacturability by qualifying ANAP as an additional assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

May 29, 2017 (date code: 1722)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	July 2016			_	May 2017					
Workweek	27	28	29	30	>	18	19	20	21	22
Initial PCN Issue Date	Χ									
Qual Report Availability						Х				
Final PCN Issue Date						Х				
Estimated Implementation Date										Х

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

July 4, 2016: Issued initial notification.

May 01, 2017: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on May 29, 2017.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_JAON-13MHBC653_Qual Report.pdf PCN_JAON-13MHBC653_Affected CPN.pdf

PCN_JAON-13MHBC653_Affected CPN.xls

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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